MS Implant System 2013 Product Catalog





MS Implant System 2013 PRODUCT CATALOG



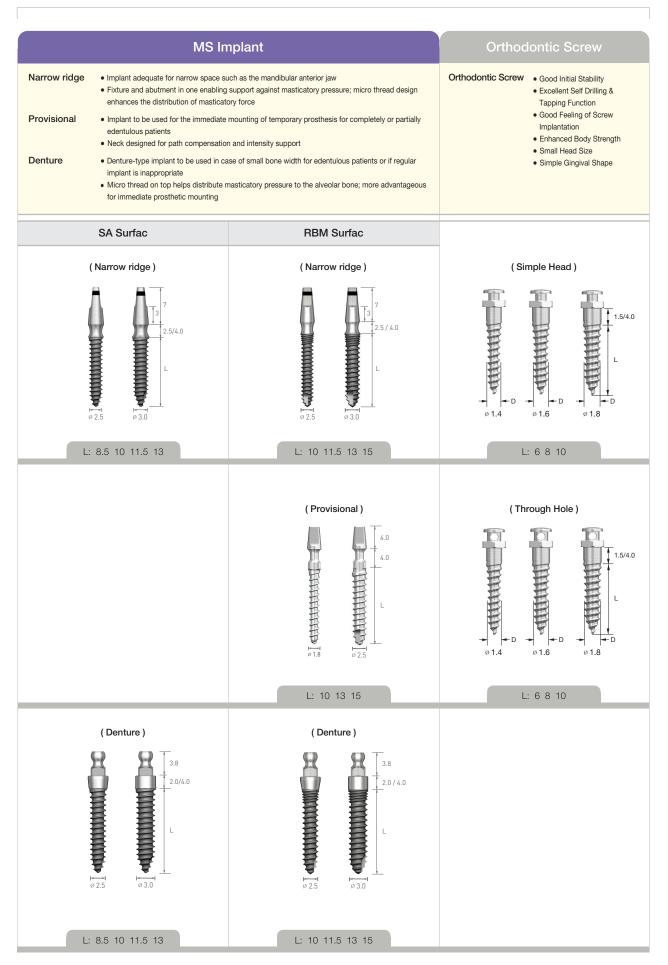
Contents | OSSTEM IMPLANT



OSSTEM HISTORY

2012		Hosts 'OSSTEM ATC Forum 2012 Seoul'	2008	Mar Opens ATC Training Center
	Jul	Registers and obtains approval from FDA in Mexico Established OSSTEM Dental Equipment Research Institute		Jan Establishes OSSTEM Bone Science Institute
	Jun	Develops and begins commercial production of TSIII CA Develops and begins commercial production of ESSET Kit for	2007	Oct Establishes subsidiary offices in Sydney, Australia [Osstem Australia PTY Ltd.]
		Ridge Split		Jun Registers and obtains approval from the TGA in Australia
	May Apr	Develops and begins commercial production of MS SA Hosts 'OSSTEM World Meeting 2012 Taipei'		May Develops and begins commercial production of US Ultra- wide
		Develops and begins commercial production of TSIII BA		Apr Hosts 'OSSTEM World Meeting 2007 in Seoul'
		Registers and obtains approval from Ministry of Health in		Begins commercial production of V-ceph
		Indonesia Develops and begins commercial production of USIII SA		Mar Develops and begins commercial production of MS Lists on KOSDAQ (KRX: Korea Exchange)
	Mar		2006	
		Develops and begins commercial production of SSIII HA	2006	Dec Establishes subsidiary offices in Bangkok, Thailand and Kuala
		Registers and obtains approval from Ministry of Health and Welfare in Kazakhstan		Lumpur, Molayria IOSSTEM Thailand Co., Ltd. and OSSTEM Malayria
				Malaysia [OSSTEM Thailand Co., Ltd. and OSSTEM Malaysia SDN, BHD]
2011	Dec	Introduces and commences commercial production of K2		Nov Registers and obtains approval from the SFDA in China
		Unit & Chair		Sep Establishes subsidiary office in Philadelphia, U.S.A [HiOssen
	Nov	Develops and begins commercial production of Smart Membrane		Inc.] Aug Establishes subsidiary offices in Beijing, China / Singapore
	Oct	Registers and obtains approval from Health Canada		and Hong Kong [OSSTEM China Co., Ltd. / OSSTEM
		Develops and begins commercial production of USII SA and		Singapore Pte Ltd. and OSSTEM Hong Kong Ltd.]
	0.1	123 Kit		Jul Establishes subsidiary office in Tokyo, Japan [OSSTEM Japan
	Sep	Establishes subsidiary offices in Dacca , Bangladesh and Ho Chi Minh City, Vietnam [OSSTEM Bangladesh Ltd. and		Corp.] Apr Registers and obtains the GOST-R certification in Russia
		OSSTEM IMPLANT Vina Co., Ltd.]		Opens 'OSSTEM World Meeting 2006 in Seoul'
		Develops and begins commercial production of SSIII SA		Publishes the $\space{-2006}$ OSSTEM IMPLANT SYSTEM $_{ m J}$ -
		Registers and obtains approval from the Ministry of Health		Introduction and particulars of implant system Jan Establishes the subsidiary offices in Moscow, Russia and
	Aug	and Society in Vietnam Establishes subsidiary offices in Manila, Philippines and		Mumbai, India [OSSTEM LLC. and OSSTEM IMPLANT India
		Vancouver, Canada [OSSTEM Philippines Inc. and HiOssen		Pvt Ltd.]
		Implant Canada Inc.]	2005	
	Jul	Develops and begins commercial production of CustomFit Abutment		Dec Registers and obtains approval by the DOH in Taiwan Establishes the subsidiary office in Ashborn, Germany
		Establishes subsidiary offices in Almaty, Kazakhstan		[OSSTEM Germany GmbH]
		[OSSTEM IMPLANT LLP]		May Develops and begins commercial production of GSI
	Jun	Develops and begins commercial production of TSII SA Hosts 'OSSTEM World Meeting 2011 in Seoul'		Apr Hosts 'OSSTEM World Meeting 2005 in Seoul' Mar Obtains KGMP(Korean Good Manufacturing Practice) in
	Apr	Develops and begins commercial production of LAS Kit		Korea
		Establishes subsidiary offices in Jakarta, Indonesia [PT		Jan Establishes the subsidiary office in Taipei, Taiwan [OSSTEM
	Mor	OSSTEM Indonesia] Establishes subsidiary offices in Guadalajara, Mexico		Corporation]
	Iviai	[HiOssen de Mexico]	2004	Nov Develops and begins commercial production of SSIII
	Feb	Develops and begins commercial production of TSIV SA		Jul Develops and begins commercial production of USIII
2010				Apr Opens 'OSSTEM World Meeting 2004 in Seou'
	Nov Aug	Develops and begins commercial productions of SSII SA Develops and begins commercial productions of TSIII Ultra-	2002	Oct Develops and begins commercial production of SSII
	- 5	wide		Aug Registers and obtains approval by the FDA in the USA
	Jun	Develops and begins commercial productions of TSIII HA and		Develops and begins commercial production of USI
		CAS Kit Opens 'OSSTEM World Meeting 2010 in Beijing'		Jan Establishes OSSTEM Implant R&D Center
	Apr	Develops and begins commercial productions of Osstem	2001	Mar Establishes AIC(Apsun Dental Implant Research & Education
		Guide		Center)
	Mar	Develops and begins commercial productions of TSIII SA		Jan Obtains CE-0434 certification
2009	Oct	Registers and obtains approval from Health, Labor and	1999	Dec Obtains ISO-9001 certification
		Welfare in Japan	1997	
	May	Hosts 'OSSTEM World Meeting 2009 in Bangkok'	1001	Dec Begins commercial production under the brand name of
	Jan	Certifies PEP7 (the world's first new Osseo-inductive compound)		OSSTEM Jan Establishes OSSTEM IMPLANT Co., Ltd. in Seoul, Korea
2008			1995	
2000	Nov	Develops and begins commercial productions of SS Ultra-	1999	Develops dental implants and acquires industrial license
	Jun	wide Develops and begins commercial productions of GSIII	1992	Initiates the development of dental implant system
	Apr	Holds 'OSSTEM World Meeting 2008 in Seou'		

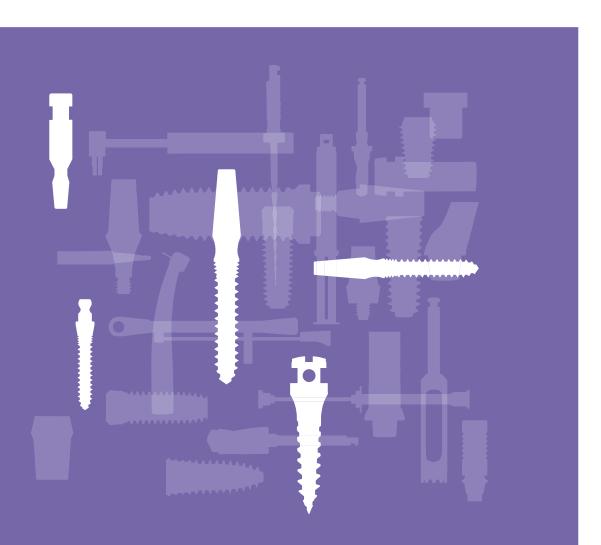
OSSTEM Implant System Flow



OSSTEM IMPLANT SYSTEM

MS SYSTEM

Fixture and Restorative Components



MS SYSTEM

EARLY & ESTHETIC OSSTEM IMPLANT

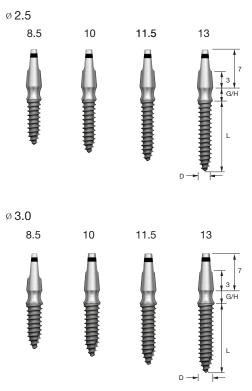
08 MS Implant Components

Narrow ridge Components Provisional Components Denture Components

- 14 Drilling Sequence for MS Implant
- 16 Orthodontic Components Simple Head Through Hole

MS Implant Components

* The following labeled dimension may differ from the actual dimension.



MS SA Implant (Narrow ridge)

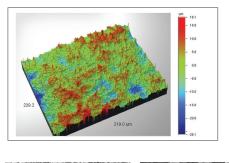
D	ø 2.5		
L G/H	2.5	4.0	
8.5	MSN2508S25	MSN2508S40	
10	MSN2510S25	MSN2510S40	
11.5	MSN2511S25	MSN2511S40	
13	MSN2513S25	MSN2513S40	

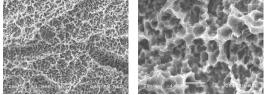
D	ø 3.0		
L G/H	2.5	4.0	
8.5	MSN3008S25	MSN3008S40	
10	MSN3010S25	MSN3010S40	
11.5	MSN3011S25	MSN3011S40	
13	MSN3013S25	MSN3013S40	

• Implant adequate for narrow space such as the mandibular anterior jaw

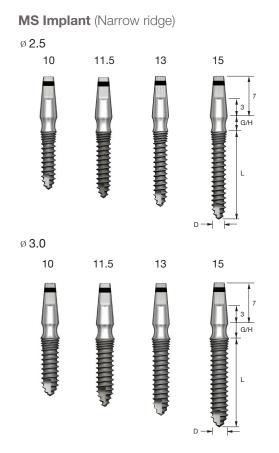
• Fixture and abutment in one enabling support against masticatory pressure; micro thread design enhances the distribution of masticatory force

- SA : Sand blasted with alumina and Acid etched surface
 - Optimal morphology : Combination of crater and micro-pit
 - Optimal surface roughness : Ra 2.5~3.0µm
 - Early cell response : 20% faster than RBM
 - Early bone healing : 20% faster than RBM
 - Early loading possible after 6 weeks of placement.
 - Optimized design for SA surface
- Optimized shape and size of abutment enabling cutting-free prosthetic work
- Optimal design of body, thread, and drilling to enhance initial boding and bone penetration
- Packing unit : MS SA Implant (Narrow ridge)
- Recommended torque : 30Ncm





* The following labeled dimension may differ from the actual dimension.



Impression Coping (Narrow ridge)



Temporary Cap (Narrow ridge)



Lab Analog (Narrow ridge)



D	ø 2.5		
G/H	2.5	4.0	
10	MSP25103R	MSP25104R	
11.5	MSP25113R	MSP25114R	
13	MSP25133R	MSP25134R	
15	MSP25153R	MSP25154R	

D	ø 3.0		
L G/H	2.5	4.0	
10	MSP30103R	MSP30104R	
11.5	MSP30113R	MSP30114R	
13	MSP30133R	MSP30134R	
15	MSP30153R	MSP30154R	

• Implant adequate for narrow space such as the mandibular anterior jaw

• Fixture and abutment in one enabling support against masticatory pressure; micro thread design enhances the distribution of masticatory force

• RBM surface design for quick osseointegration

Optimized shape and size of abutment enabling cutting-free prosthetic work

 Optimal design of body, thread, and drilling to enhance initial boding and bone penetration

- Packing unit : MS Implant (Narrow ridge)
- Recommended torque : 30Ncm

Code	MSPIC

- Use for precise impression work
- In case of non-modification of abutments : after taking an impression using an impression cap, make the prosthesis after creating a model using an analog
- In case of modification of abutment height only: after taking an impression using an impression cap, create a model using an analog and make the prosthesis by modifying the model shape according to the modification of abutment
- Packing unit : Impression Coping

Code	MSPTC	
king temperany presthesis		

- Use for making temporary prosthesis
- One-touch locking design
- Packing unit : Temporary Cap (Narrow ridge)

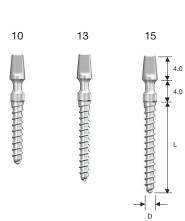
Code	MSPLA

- Make an MS Implant (narrow ridge) abutment of the oral cavity onto a working model
- Packing unit : Lab Analog

MS Implant(Provisional) Components

MS Implant (Provisional)

ø **1.8**



13

THILLEP

L	ø 1.8
10	MST18104
13	MST18134
15	MST18154

• Recommended torque : 25Ncm

ø2.5



15	10
15	13
4.0	15
4.0	 Implant to be used completely or partia Neck designed for Simple system to n
	caps and lab analo Provisional cap fac

L	Ø 2.5
10	MST25104
13	MST25134
15	MST25154

- Implant to be used for the immediate mounting of temporary prosthesis for completely or partially edentulous patients
- Neck designed for path compensation and intensity support
- Simple system to make temporary prosthesis using titanium provisional caps and lab analogs
- Provisional cap facilitating prosthetic work on the chairside
- Rectangular structure to connect a driver to the bottom of the neck, thereby facilitating removal
- Optimized design of body, thread, and drilling to enhance initial bonding and bone penetration
- Packing unit : MS Implant (Provisional)
- Recommended torque : 30Ncm

Provisional Cap (Provisional)



Lab Analog (Provisional)



Code

• Use for making temporary prosthesis (Titanium)

Packing unit : Provisional Cap

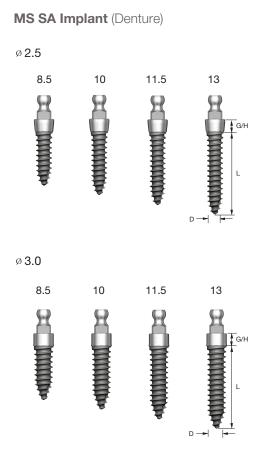
Code	MSTLA

MSTPC

- Make an MS Implant (provisional) abutment of the oral cavity on a working model
- Packing unit : Lab Analog

MS Implant(Denture) Components

* The following labeled dimension may differ from the actual dimension.

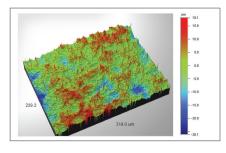


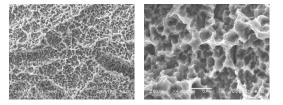
D	ø 2.5	
L G/H	2.0	4.0
8.5	MSD2508S20	MSD2508S40
10	MSD2510S20	MSD2510S40
11.5	MSD2511S20	MSD2511S40
13	MSD2513S20	MSD2513S40

D	ø 3.0		ø 3.0	
L G/H	2.0	4.0		
8.5	MSD3008S20	MSD3008S40		
10	MSD3010S20	MSD3010S40		
11.5	MSD3011S20	MSD3011S40		
13	MSD3013S20	MSD3013S40		

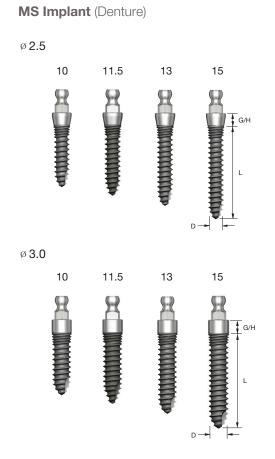
• Denture-type implant to be used in case of small bone width for edentulous patients or if regular implant is inappropriate

- SA : Sand blasted with alumina and Acid etched surface
 - Optimal morphology : Combination of crater and micro-pit
 - Optimal surface roughness : Ra 2.5~3.0µm
 - Early cell response : 20% faster than RBM
 - Early bone healing : 20% faster than RBM
 - Early loading possible after 6 weeks of placement.
 - Optimized design for SA surface
- Micro thread on top helps distribute masticatory pressure to the alveolar bone; more advantageous for immediate prosthetic mounting
- Easy and convenient denture work through the possible use of retainer and lab analogs
- Ball-type structure for the connection of the O-ring attachment
- Use by selecting 2/4mm depending on the gingival height
- Packing unit : MS SA Implant (Denture)
- Recommended torque : 30Ncm





* The following labeled dimension may differ from the actual dimension.



D	ø 2.5	
L G/H	2.0	4.0
10	MSD25102R	MSD25104R
11.5	MSD25112R	MSD25114R
13	MSD25132R	MSD25134R
15	MSD25152R	MSD25154R

D	ø 3.0	
G/H	2.0	4.0
10	MSD30102R	MSD30104R
11.5	MSD30112R	MSD30114R
13	MSD30132R	MSD30134R
15	MSD30152R	MSD30154R

- Denture-type implant to be used in case of small bone width for edentulous patients or if regular implant is inappropriate
- Micro thread on top helps distribute masticatory pressure to the alveolar bone; more advantageous for immediate prosthetic mounting
- Easy and convenient denture work through the possible use of retainer and lab analogs
- Ball-type structure for the connection of the O-ring attachment
- Use by selecting 2/4mm depending on the gingival height
- Packing unit : MS Implant (Denture)
- Recommended torque : 30Ncm

O-ring Retainer Cap Set





Lab Analog (Denture)



Name	Code
O-ring Retainer cap set	RCS01
O-ring set	OAON01S

• Use for making stud-type overdenture

• Packing unit : Retainer Cap+ O-ring

Code		MSDLA	

• Make an MS Implant (denture) abutment of the oral cavity on a working model

Packing unit : Lab Analog

HM KIT (MS KIT)



• HM Implant KIT

Code

• KIT Components (basic)

- 5-drill set
- ø1.5mm Lance Drill
- ø1.8mm Twist Drill Long
- ø1.8mm Twist Drill Short
- ø 2.3mm Twist Drill Long
- ø 2.3mm Twist Drill Short

- Torque Driver Long (Narrow Ridge)

4-driver set

- Machine Driver Short (Denture)

- Machine Driver Long (Narrow Ridge)

HMISLK

- Torque Driver Short (Denture)

1-etc

- Torque Handle

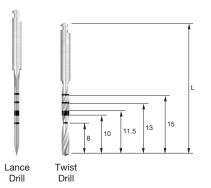
4-etc

- Depth Gauge
- Parallel Pin
- Driver Separator
- Ratchet Wrench

• KIT Components (optional)

- Machine Driver Short (Narrow Ridge)
- Torque Driver Short (Narrow Ridge)
- Torque Driver Long (Denture)

Drill for MS Implant



Name	D	L	Code
ø 1.5mm Lance Drill	ø 1.5	35	OSLD15
ø 1.8mm Twist Drill Long	ø 1.8	42	OSMSD18L
ø 1.8mm Twist Drill Short	ø 1.8	32	OSMSD18S
ø 2.3mm Twist Drill Long	ø 2.3	42	OSMSD23L
ø 2.3mm Twist Drill Short	ø 2.3	32	OSMSD23S
ø 2.5mm Twist Drill Long	ø 2.5	42	OSMSD25L
ø 2.5mm Twist Drill Short	ø 2.5	32	OSMSD25S

• Same specification as implant length for easy identification ; laser marking on 8/10/11.5/13/15mm For lance drilling, drilling only the cortical bone is recommended; enables drilling up to the laser marking line depending on the surgeon's work environment

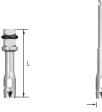
Driver for Narrow Ridge & Provisional Type



Torque Driver

Machine Driver

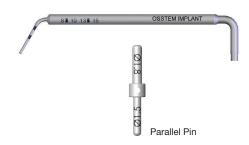
Driver for Denture type



Torque Driver

Machine Driver

Gauge for MS Implant



Name D L Code Torque Driver (Short) Ø3.4 16.5 **MSPTS** Torque Driver (Long) Ø 3.4 21.5 MSPTL Machine Driver (Short) Ø3.4 24.4 **MSPMS** Ø3.4 MSPML Machine Driver (Long) 29.4

• Special-purpose driver for MS Implant (Narrow Ridge and Provisional) The triangle mark is used by aligning with the implant cross section

Name	D	L	Code
Torque Driver (Short)	Ø 3.8	13.5	MSDTS
Torque Driver (Long)	Ø 3.8	18.5	MSDTL
Machine Driver	Ø 3.8	21.4	MSDMS

• Special-purpose driver for MS Implant (denture)

The triangle mark is used by aligning with the implant cross section

Name	Code
Depth Gauge	MSDG
Parallel Pin	MSPP

Depth gauge

Left : For depth checking upon drilling

Right : Use for MS implant bending

• The parallel pin is used for path checking upon drilling

Code	MSTH
Use for manual torgue after connect	ing to the connected part of a torque

 Use for manual torque after connecting to the connected part of a torque driver

Code	MSDS
 In case a driver is stuck during graffi 	ng separate based on the lover

 In case a driver is stuck during grafting, separate based on the lever principle (inserting a driver separator into the driver groove)

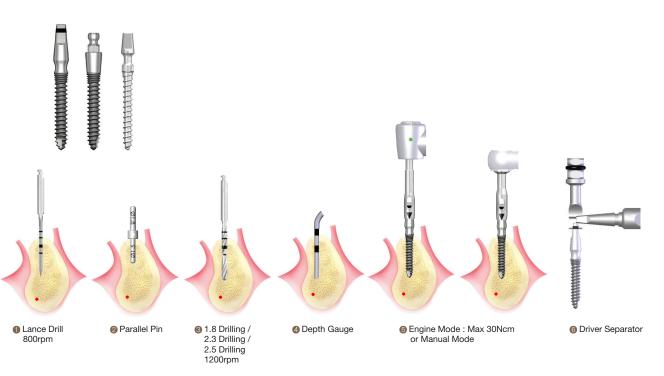
Torque Handle



Drilling Sequence for MS Implant

MS Fixture

Ø2.5mm / Ø3.0mm Fixture



Ø 1.8mm Fixture









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